PATENT SPECIFICATION

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(54) COMPOSITE PHOTO-SENSITIVE ELEMENTS

(71) We, E. I. DU PONT DE NEMOURS AND COMPANY, a Corporation organized and existing under the laws of the State of Delaware, located at Wilmington, State of Delaware, United States of America, do hereby declare the invention for which we pray that a patent may be granted to us, and the method by which it is to be performed, to be particularly described in and by the following statement:—

This invention relates to composite, photo-

sensitive elements.

In both the graphic arts and electronics industry, it has become common practice to use 15 photosensitive elements because of their high uniformity, ease of preparation, lower cost and other well-known factors. During the process of manufacture, copies must often be made which require the use of so-called "masks". 20 These masks are copied from original "art-work" carefully prepared by draftsmen. One system, for example, prepares a copy of the artwork original on a silver halide lithographic film. This system is commonly used during the preparation of printed circuits. The silver halide film must then be "bleached" to reduce the image density so that the operator may see through the image to line up the copy while working in safelights. The safelight used here 30 is that which masks out the ultraviolet portion of the spectrum toward which a photopolymer resist composition is sensitive; the safelight is usually a yellow color. Under this light, the black, developed silver prevents the operator 35 from seeing through the image to line up the copy. The bleaching process, however, produces a brown color through which the operator may readily see while preparing subsequent copies. This risibility is very important as often the operator must place several image copies, one on top of the other, and the resultant "registry" must be perfect in preparing the subsequent copy. The inherent drawbacks of this system are obvious. There are 45 numerous steps in producing the mask, such as exposure, development, bleaching, washing, all done with silver halide safelights, which, because of the inherent nature of the photographic silver halide system, are different from the photopolymer safelight system. In addition, a defect known as "pin-holes" is common to the silver halide system and subsequent passage of ultraviolet light through these pinholes produces unwanted exposure in the photopolymer copy. This defect is extremely undesirable in the printed circuit industry and cannot be tolerated. Hence, many masks must sometimes be made in order to produce one which is satisfactory, resulting in great waste and cost. In addition, the bleaching process removes excess silver which is either lost or which must be recovered from the processing solution which adds cost to the system. Finally, after several exposures, the bleached image reverts back to a highly blackened state, preventing the operator from obtaining registry, and the mask must be discarded. Thus, the life of this type mask is shortened by use.

Yet another system uses so-called "photomasks" for the preparation, for example, of integrated circuits by photolithographic techniques. These masks are copied by the process of photoreduction from the original artwork, as taught by Madlen et al. in "Integrated Circuit Engineering-Basic Technology", Chapter 3, 4th Edition (1966), published by The Boston Technical Publishers, Inc. The original artwork, termed a "photo master", is prepared 200-1000 times the actual size desired and is zealously protected because of the high cost of preparation. Photomask copies of this original are usually made on, example, optically clear photographic glass plates coated with a fine grain, Ligh resolution silver halide emulsion, such as the "Lippman" type. Because of the delicate and fragile nature of these masks, only a limited number of copies can be made. In addition, they, too, suffer from pin-hole defects described above. Another type of mask commonly used for this 50

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process is taught by George and Seaman in "Photo Methods for Industry", October, 1967, pp. 66—67. These are the "metal-on-glass" type which are usually thin depositions of a Ni-Cr-Fe alloy or chromium on a glass substrate. A photoresist layer is then coated on top and the original "photo master" imaged on this photoresist by known techniques well described in the above reference. The area ·10 of the photopolymerisable layer which is left unhardened is washed off by solvent development and the metal "etched" through to the glass in these areas with special etching solutions such as inorganic acids. The remainder of the hardened photoresist is then removed and the metal image cleaned thoroughly leaving a suitable photomask. The metal mask is far superior to the emulsion mask due to its durability and ability to reproduce the original with greater fidelity. However, its manufacturing cost is very high and the number of steps required to prepare the mask make its use prohibitive in those areas where cost is a major factor. These metal masks also suffer from pinhole defects and are also relatively opaque to visible light which makes it difficult to obtain good registry.

The present invention provides a composite, photosensitive element which overcomes the disadvantages of the prior art and comprises:

(a) a photosensitive layer comprising either

 (i) a photohardenable material which hardens
 upon exposure to actinic radiation or (ii) a
 crosslinkable photosensitive composition which
 undergoes decomposition upon exposure to
 actinic radiation to leave material in the unexposed areas which cross-links and hardens
 upon treatment with a basic crosslinking agent;
 and, in intimate surface contact therewith,

(b) a layer of a solvent-soluble (as hereinafter defined), macromolecular organic polymer, which layer (b) contains at least one dye or pigment and is essentially opaque to ultraviolet radiation and essentially transparent to visible actinic radiation.

The layer (a) may thus contain either (i) a photohardenable material or (ii) a crosslinkable photosensitive material. Example XI illustrates the use of the latter type of material; in this Example there is used a photosensitive diazonium compound which decomposes upon exposure to actinic radiation but which crosslinks in the unexposed areas when treated with ammonia to provide a solvent-insoluble material. By the term "solvent soluble" is meant that the polymer of layer (b) should be soluble in a solvent used to develop an element which has been exposed imagewise by dissolving and removing unhardened material in the unexposed or exposed areas of layer (a) while not dissolving hardened material in the remaining areas of layer (a).

Preferably the composite, photosensitive elements comprise a cover sheet (A) adherent to layer (a) and a support film (B) adherent to layer (b).

The composite film should be essentially transparent to actinic light in the visible region of the spectrum, but should, by reason of the ultraviolet dye or pigment mixed in the UV-absorbing layer (b), provide an optical density of at least 0.5 or more, e.g. up to 5.0, to that region of the spectrum to which the layer (a) is photosensitive, namely, between 200—500 mu. The photoresist-forming layer (a) and the UV-absorbing layer (b) should adhere strongly enough to each other to resist rupture when the cover sheet (A) or support film (B) is stripped from the contiguous surface.

A mask suitable for transparent lithographic work can be provided if support film B adheres more strongly to the UV-absorbing layer (b) than cover sheet A adheres to the photoresist-forming layer (a). One exposes the photoresist-forming layer through cover sheet A, then peels off "A" for wash-off development to leave a suitable mask on support film R

A suitable photomask can be provided by a reverse adherence factor, that is, support film B adhering less strongly to the UV-absorbing layer (b) than cover sheet A adheres to the photoresist-forming layer (a). When film "B" is peeled off, the remaining three layers can be laminated to a dimensionally stable and rigid support, for example, optical glass. After lamination and exposure, cover sheet A is removed and solvent development of layer (a) yields the photomask under the 100 resist.

Both elements provide masks possessing all the fidelity and sharpness of currently available systems, yet masks may be produced at substantially lower cost and with considerably less handling by operators. In addition, the elements described herein are transparent to visible light allowing the operator to obtain good registry when reproducing copies from these masks. The relative low cost due to less 110 handling permits more latitude when eccidental errors or mistakes occur. Masks can be provided that are relatively free of pin-holes and other coating defects associated with silver halide emulsions or metal masks. They are also 115 more resistant to scratches which can occur to the mask during normal handling. In addition, the masks are resistant to fading, and thus have a longer life than those silver halide systems described above. The entire system 120 itself is compatible with other photopolymer systems allowing them to be used and handled in relatively bright safelights. This factor is important to the users of photopolymer systems such as those in the printed circuit industry. 125 The new and useful masks can be used under the same safelight system to which they had been subjected to previously.

In a preferred embodiment the composite, photosensitive elements comprise:

a photosensitive layer in intimate contact with

(b) a layer of a solvent-soluble resin, e.g. polyvinyl acetate, containing an ultraviolet radiation-absorbing agent in a concentration to provide absorption of at least 99% of actinic radiation in the 10 region of the spectrum from 200-500 mu, and the layer mixture, when in the form of a thin film or coating, exhibiting an optical density to the actinic radiation of 0.5 or more and preferably of 1.0 or more. 15

Adhesion of the two layers should be strong enough to resist rupture when the cover sheet or support film is stripped from either one of the intermediate layers. The layers may be coated or laminated together, as known to those skilled in the art. Both layers (a) and (b) preferably are disposed between the support film and cover sheet of polyethylene terephthalate or polyethylene. The support film and cover sheet serve to support or to protect both the UV-absorbing layer and the photohardenable layer.

The elements described above may be used as a transparent lithographic mask by exposing through the cover sheet, removing the cover sheet A, developing the resulting image by removing the unhardened areas of layer (a), and removing the portion of layer (b) underlying the unhardened layer mask on the support Concurrently, the elements described above may be used as a photomask by first stripping the support film B from the UV-absorbing layer (b), laminating the remaining three layers to a more rigid or a more dimensionally stable support C with the UV-absorbing layer (b) nearest the support, then exposing the photoresist-forming layer to actinic radiation, removing the cover sheet A 45 on the photoresist-forming layer (a), and developing as described above, leaving a photomask on the rigid support C

The polymeric, solvent-soluble, ultraviolet radiation absorbing layers use as binders macromolecular organic polymers that form solid films, e.g. polystyrene, copolymers of vinylidene chloride and acrylonitrile, polyacrylates and polymethacrylates, polyamides and polyvinyl esters. These polymers may have molecular weights ranging from 500-150,000 and should be soluble in solvents or developing solutions commonly used to develop photoresists, such as, for example, methyl chloroform, trichloroethylene, mixed solvents, such 60 as methylisobutylketone-isopropanol and others known to those skilled in the art. This invention is not limited necessarily to those solvents useful for developing photoresists, however, but the solvents useful in attacking and 65 removing the polymeric UV-absorbing layer

must necessarily be unable to dissolve the hardened areas of the adjacent image. More useful elements are those in which the same solvent is used to develop the photoresist image and to simultaneously dissolve the polymer layer containing the UV-absorbing dye or pigment, resulting in less handling.

Any ultraviolet radiation-absorbing agent can be mixed with or dispersed in the solventsoluble polymer binder or matrix, to produce the subsequent mask. Useful agents are 2,3-dihydroxybenzophenone and 2,2'-dihydroxy-4methoxybenzophenone.

Since some photosensitive image-forming layers are also sensitive to actinic radiation just beyond the UV region of the spectrum, and since most UV dyes have rather most dyes have sharp cut-off points, it is also useful to incorporate yellow or orange dyes, such as Oil Yellow 3G (Colour Index No. 29) and "Luscol" Fast Yellow T (Colour Index No. 47) with UV-absorbing layer. Alternatively, maye use a single dye which absorbs both in the yellow and in the ultraviolet portion of the spectrum. With respect to the UV-absorbing layer, the optical density of the ultraviolet absorber/dye/matrix layer in the actinic region should be at least 1.5-5.0 and prevent subsequent passage of actinic radiation in the spectral region which is used to initiate photosensitization, namely, from about 200-500 mu. Photosensitive compositions and elements useful for making the layer coated over the UV absorber disclosed above, 100 to provide a combination which will produce the dyed image to be used as the mask, are legion in number and include those uniformly crosslinkable photo hardenable materials Patent 3,526,504, 105 disclosed U.S. in photopolymerizable compositions of and U.S. 3,469,982. Patent The they resists crosslink when posed to actinic light rich in ultraviolet radiation, as taught in U.S. Patent 3,526,504, and 110 form a hard, polymeric surface in those exposed regions. Other useful resist or resist-like layers are described by J. Kosar in "Light-Sensitive Systems", 1965, published by John Wiley and Sons. These include the so-called 115 "cinnamates" as described on page 140 et seq. of the above reference, dichromated colloids as described in Chapter 2 and diazo-type processes as described in Chapter 6 of the above reference as well as many other common resist 120 formulations commercially available and well known to those skilled in the art. These layers may be coated individually on separate supports and then laminated together, or sequentially coated or extruded on top of each other 125 and then coated or laminated on the support films or by other techniques well known to those skilled in the art. By applying so-called "subbing" layers to the support or cover sheet, one can make either the support or cover sheet 130

have a tendency to adhere to a stronger degree to the contiguous layer than the other.

Examples of binder or matrix compositions useful for the ultraviolet radiation-absorbing layer are as follows:

Chemical Composition	Molecular Weight	Viscosity (cps in Soln. Shown at 25°C)	Melting Point (°C)
Polystyrene Resin	1500	800 (46% toluene)	100
Polystyrene Resin	300-400	6000 (80% toluene)	75 [.]
Poly(vinylidene chloride)-actylonitrile copolymer	<u> </u>	80 (20% in methylethyl- ketone)	-
Poly (vinyl chloride)	_	40 (20% in acetone)	_
Polyamide (Melt Index of 10 at 225°C)) –	- .	–15 to –10
Poly (vinyl formal)	26-34,000	_	_
Poly (vinyl butyral)	45-55,000	_	_
Cellulose acetate butyrate	_	98 (15% in benzene)	
90 mole % methyl methacrylate 10 mole % methacrylic acid	30,000	2-ethoxy-ethanol	
Linear y-methyl-styrene resin	-	10,000 at 149°C. (60% in toluene)	
Poly (vinyl chloride-vinyl acetate) copolymer (89.5-91.5 PVC)	-	-	_
Poly (vinylchloride)/maleic acid/vinyl acetate copolymer (85-88% PVC; 0.8-1.2 MA; 10% VA)		70 (15% Soln. in toluene)) _
Poly (methyl methacrylate)/methacrylic acid copolymer — pH = 8	-	500 (29.5–31.5% in H ₂ O)	-
Chlorinated rubber* ("Parlon"-S)	_	17-25 (25% in benzene)	_
Poly (vinylpyrollidene) styrene copolymer		1000 (melt viscosity)	_
Poly (methyl methacrylate)	30,000	70-1400 (37.5% in toluer	ne) _
Poly (vinyl alcohol) 99—100% hydroly _ed		55-65 (4% in H ₂ O at 20°C)	-
Poly (vinylpyro.iidone)-vinyl acetate copolymer	-	25,000 (melt viscosity)	_

^{* 30%} chlorize (Hercules Chem. Corp.)

Primrose Yellow

Chrome Yellow

Chrome Yellow

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5	Examples of ultraviolet dyes, absorbers and other dyes which persed in or mixed with the binde above are listed below: 2,2'-dihydroxy-4-methoxy-benzothed decyloxy-2-hydroxybenzophenone hydroxyphenylbenzotriazole 2(2' - hydroxy - 5' - methopenzotriazole	can be of can describ ophenone nenone	dis- bed	resorcinol-monobenzoate 2-hydroxy-4-methoxybenzophenone 2,2' - dihydroxy - 4,4' - dimethoxy - benzophenone 2,2',4,4'-tetrahydroxybenzophenone 2 - hydroxy - 4 - methoxy - benzophenon 5-sulfonic acid (also sodium salt of above) ethyl-2-cyano-3,3-diphenylacrylate 2-ethylhexyl-2-cyano-3,3-diphenylacrylate			15
	"Luxol" Fast Orange	GRL (/ Color	Index	¢ #25	(Solvent Orange)	
		GS	,,	**	#24	11 21	
		. R	,,	••	#20	**	
	"Plasto" Orange	М	,,	,,	#21 _.	" "	
		RS	"	•	#22	** **	
	Oil Orange		•	,,	#12055	(Solvent Yellow #14)	
	Sudan Orange	RA	,,	٠,	#12055	(Solvent Yellow #14)	
	Latyl Orange	3R	,,	,,	#26	(Disperse Orange)	
	Capracyl Orange	R	**	••	#60	(Acid Orange)	
	"Luxol" Fast Yellow	G	**	**	#45	(Solvent Yellow)	
		T .	••	,,	#47	" "	
	"Plasto" Yellow	GR	**		#39	,	
		MGS	**	**	#40	" "	
	Oil Yellow	3G	**	,,	#29	"	
		N		**	#2	** **	
	Sudan Yellow		,,	11	#30	11 11	
	Latyl Yellow	3 G	**	••	#54	(Disperse Yellow)	
	Latyl Orange	NST	,,	••	#25	(Disperse Orange)	
	Capracyl Yellow	N	,,	••	#113	(Acid Yellow)	
	Latyl Yellow	YWL	,,	,,	#42	(Disperse Yellow)	
	· Capracyl Yellow	NW.	••	••	#113	(Acid Yellow)	
	Capracyl Orange	R	,,	**	#60	(Acid Orange)	•
	Bakcar Yell ow	CY	••	. ,,	#75	(Disperse Orange)	
	Yellow	2G	,,	,,	#3	(Disperse Yellow)	

#77603

#77603

#77600

Light ,,

Medium "

(Pigment)

		• • • • • • • • • • • • • • • • • • • •							
	Dis	persed Manganese dio	xide						
	Tol	uidine Yellow	GW	••	,,	47 1680	11		
	Mol	ybdate Orange		**	••	# 7760 5	**		
	Dal	amar Yellow		,,	٠,	#11741	**		
	Gre	en Gold		,,	,,	#12775	,,		
	Gra	phtol Yellow		".	,,	Pigment Ye	ellow #61		
	Gra	phtol Orange		••	,,	Pigment Or	range #13		
	Vic	toria Pure Blue	во	,,	**	#42595			
	the follow	vention will be further ing examples. EXAMPLE I.			Soluthic	in th ition A was k polyethyler	es. at 25°C using e Brookfield Vis machine coated ne terephthalate o	cometer on 0.18 mm dear film pre-	45
5	Solution	lowing two solutions w A (for use in Prepa: Absorber Layer) 15% acrylic hydros which is a terpolyme	ring the Usol in was	ter,	Pate on the	ent 2,779,684 one side onl resin subbe	bed in Example 4, containing a re y. Solution A w d side using an	esin sub layer vas coated on air knife as	50
10		55% methyl methal ethyl acrylate and 5% 30% solids by weighticle size of 0.01—0.0	crylate, 40 6 acrylic act at with a p 05 micron.	0% cid, par-	and in t lam axia	drying Soluthe same mandinated with lly oriented	killed in the art. tion B was coated iner and the rest a 0.019 mm thi and heat-set	d on top of A ulting product ick, clear, bi- polyethylene	55
. 15	95 gm	#60 Bakcar Yellow CY,	Colour Inc	dex	havi A ethy mer	ng the struis biaxially- lene terepht izable layer	n to yield a comp cture set forth oriented and h halate, (a) is (from Solutio	above, where eat-set poly- a photopoly- n B) about	60
20	1000 gm This mix then the f	ture was stirred for o ollowing was added:	one hour a	and	mat resid The	orbing layer ely 0.0025 r r subbed po finished pro	lry thickness, (b (from solution nm dried thickn llyethylene terepl duct was given a	A), approxi- sess and B is shithalate film. 2-minute ex-	65
25	5 gm	trimethylolpropane to concentrated sodium (10% in water) 1 10% water solution ated hydrogerbon wh the following chemic	lauryl sulf of a fluor nich posses	rin- sses	at a whice ted pho	p-Top" Plat distance of th was a sten circuit. Afte toresist imag	on arc ("muArc" te Maker Model 45.7 cm through acil drawing simular stripping off ge formed on following solution	FT26M—2) a test image lating a prin- sheet A, the (a) was de-	70
		CH ₂ —CH ₃	11						
30	$(C_8F_{17}-$	- SO ₂ N CH ₂	Ċ—0 °)¤	ζ θ	60		Butoxy)ethanol phenoxyethoxy e	thanol	7 5
	Solution 1	B (for use in Preparir resist Layer)	ng the Pho	to-			ium silicate sol	lution (60%	
•	600 gm	copolymer of methy (90 mole %) and me	lmethacryl	ate	W	ater to 1 lit	er		
. · ·	24 gm	(10 mole %) dimer of o-chlorophen methoxyphenyl)imida	yl-4,5-bis(resis	t image on ti	ot only develope he photopolymer neric UV-absort	but also dis-	80
40	12 gm 72 gm	4,4' - bis(dimethylaphenone	amino)ben:		the a	identical area llow colored	a under the image, exact positive as useful for pre	ge producing copy of the	85
	300 gm	caproate and -dicapry	late		copi	es. E	XAMPLE II.		w

	Solution A	
	1000 gm	poly(vinyl acetate)—having a viscosity of 13 to 18 cps as an
		viscosity of 13 to 18 cps as an
		8.6% solution in benzene at
5		20°C.
	60 gm	terpolymer made by reacting 1200
		gm methyl methacrylate, 50 gm
		methacrylonitrile and 500
		gm methacryloxypropyltrimeth-
10		oxysilane which had a molecular
		weight of 15,700 and an analysis
		of 1.03% N and 3.15% silicon
	100 gm	
	100	ate 2,2' - dihydroxy - 4 - methoxy-
15	100 gm	benzophenone
	100 ~~	
	100 gm	Index #47
	100 am	ethyl alcohol
20	14500 gm	
20	This solution	on contained about 7% solids and
	had a visco	sity of 17 cps at 25°C.
		•
	Solution B	
	578 gm	poly(methyl methacrylate) —
25		molecular weight 30,000
	220 gm	poly(methyl methacrylate) —
		molecular weight 60,000
	95 gm	terpolymer described in "A"
	835 gm	trimethylolpropane trimethacrylate triethyleneglycol diacetate
30	135 gm	o - chlorophenyl - 4,5 - bis(n-
	24 gm	methoxyphenyl)-imidazole dimer
	. 0	7 - diethylamino - 4 - methyl-
	9 gm	coumarin
35	9 gm	2-mercaptobenzothiazole
33	1,000 gm	methyl alcohol
	7975 gm	methylene chloride
		•

This solution contained about 17.5% solids. Solution "A" was coated on 0.023 mm-thick clear, biaxially oriented and heat set polyethylene terephthalate film. Coating was accomplished by the use of a "doctor" knife. After drying, the film was laminated with 0.025 mm-thick polyethylene to protect the 45 resulting UV-absorbing layer which had a dried thickness of about 0.010 mm and the following optical densities, as observed on a Cary Optical Spectrophotometer:

This UV-absorbing layer was next transferred to a 7.62 cm × 10.16 cm projector slide cover 55 glass, which had been thoroughly cleaned by scrubbing with solvents. Transfer was accomplished by removing the polyethylene cover sheet and laminating the UV-absorbing layer to the glass plate through heated rollers at 60 100-120°C at approximately 1.83 m/min.

Solution B was coated on 0.019 mm-thick, clear biaxially oriented and heat set polyethylene terephthalate base in the same manner. After drying, this photoresist layer, which was about 0.010 mm-thick, was laminated with a polypropylene cover sheet to protect the imaging layer during subsequent handling.

*The polyethylene terephthalate support film was stripped from the UV-absorbing layer which had been firmly laminated to the glass and the polypropylene cover sheet removed from the photoresist layer and the two layers laminated together as described above, providing a laminated photopolymerizable element having the structure set forth above, where A is polyethylene terephthalate, (a) is photo-polymerizable layer, (b) is UV-absorbing layer, and B is glass.

The photopolymerizable layer (a) was then given a 10-second exposure at 40.6 cm with a 1000-watt quartz iodide lamp through a negative containing a standard test pattern comprised of simulated electronic printed circuitry. The polyethylene terephthalate sheet A was removed by stripping and the resulting image developed by dipping in a solution consisting of 90% methylisobutylketone/10% isopropanol, followed by a water spray, and the resulting yellow image dried by blowing with compressed air. The solvent used herein dissolved both the unhardened areas of the photoresist and subsequently the dyed, polymeric underlayer leaving a suitable, positive mask on a rigid glass support useful for imaging photoresists with light sensitivity of between 300-450 mu.

EXAMPLE III.

The same compositions outlined in Example II were prepared and coated on their respective substrates as previously described. After 100 stripping off the protective polyethylene cover sheet from the UV-absorbing layer Solution A, it was laminated by the same technique to a piece of clear poly(methylmethacrylate). The photoresist layer was next joined to the UV- 105 absorbing layer on the poly(methylmethacrylate), as previously described, to form a composite film element having the structure that is set forth above, where A is polyethylene terephthalate, (a) is photoresist, (b) is UV- 110 absorbing layer and B is poly(methylmethacrylate). A negative test image was exposed through layer A on to layer (a) with a sixsecond exposure to a 1000-watt quartz-iodide lamp at a distance of 40.64 cm. Layer A was 115 removed and the photoresist image developed by spraying with methylchloroform for 30 seconds followed by a second spray of 2methoxyethanol and a prolonged water spray. The positive yellow image on the rigid poly- 120 (methylmethacrylate) support suitable for use as a photomask, was then dried with compressed air.

	TSTALLES TO THE		_
	EXAMPLE IV. Solution A, for use as the UV-absorbing layer, was prepared as follows:	7970 gm methylene chloride Viscosity=17 cps at 25°C	65
5	2000 gm of the acrylic hydrosol described in Example I	terephthalate film yielding a dried thickness of	
	50 gm 10% sodium lauryl sulfate in water 30 gm fluoronated hydrocarbon, 10%	of polypropylene. The photopolymerizable	70
10	water solution as described in Ex- ample I	propylene cover sheet, this photoresist was	
	This slurry was heated to 35°C and the mix- ture shown below was added slowly:	the hot roller technique described in Example	75
15	40 gm Latyl Yellow 3G, Colour Index #54 35 gm "Luxol" Fast Orange GS, Colour	cover film and exposed 5 seconds at 40.64 cm	
•	Index #24 20 gm 2,2' - dihydroxy - 4 - methoxy- benzophenone	stripping the polyethylene terephthalate film off, the photoresist image was	80
20	This material was coated on 0.18 mm-thick polyethylene terephthalate clear film subbed.	for 1 minute. The anodized aluminum	
	and prepared as described in Example IV of U.S. Patent 2,779,684, using a "doctor" knife resulting in a dried coating which was 0.005	was etched in those areas where the photo- resist layer had been removed by dipping in	8
25	mm thick. Once again, this coating was lamin- ated with a thin sheet of polyethylene to pre- vent damage to the surface during storage	leaving an exact replies of the character	
•	and transfer. After removal of this cover sheet, the photoresist element of Example II	EXAMPLE V.	90
30	was laminated to the UV-absorbing layer on the resin-subbed polyester to form a laminated	Solution A, for use as the UV-absorbing layer, was prepared as follows:	
	photopolymerizable element having the com- posite structure that is set forth above, where A is polyethylene terephthalate, (a) is photo-	100 gm 5% poly(vinylacetate) in water (viscosity is 55—65 cps at 20°C using the Hoeppler falling ball	•
35	resist (b) is UV-absorbing layer and B is resin-subbed polyethylene terephthalate. A negative test image was laid on top of A, ex-	method) 1 gm Oil Yellow 3G, Colour Index #29	95
40	posed 10 seconds to a 1000-watt quartz inclide lamp at a distance of 40.64 cm. A was stripped	Index #47 1 gm 2,2' - dihydroxy - 4 - methoxy-	100
40	off and the photoresist image on (a) developed by spraying for 35 seconds with methyl chloro- form followed by a 15-second spray with 2-(2-	50 ml ethyl alcohol	
	butoxy) ethanol and a 1-minute spray with water. This development procedure also dis-	After vigorous stirring this mixture was coated on polyethylene terephthalate clear film pre-	
15	solved the UV-absorbing layer in the same area below the image. The resulting orange-yellow image was dried with compressed air to pro-	pared and subbed in the manner as described in U.S. Patent 3,443,950 and which has been also coated with a thin anchoring substratum	105
	vide a photomask. A photopolymerizable material of the following composition was	of gelatin (0.5 mg/dm ²). After drying, the UV-absorbing layer had a thickness of 0.05	
0	then prepared:	comprising the photopolymerizable layer (a)	110
	525 gm poly methyl methacrylate), mol. wt. 50,000	and polyethylene terephthalate base A was laminated on top of the dried UV-absorbing	
55	300 gm pc y (methyl methacrylate), mol. wi. 60,000	layer to form a composite photopolymerizable film having the structure that is set forth	115
	525 gm trimethylolpropane triacrylate 128 gm triethyleneglycol diacetate 9 gm 4,4' - bis(diethylamino) benzo-	above, where A is polyethylene terephthalate, (a) is photoresist, (b) is UV absorber layer and B is gel-subbed polyethylene terephthalate.	
0	phenone 42.3 gm o - chlorophenyl - 4,5 - bis(n-	A test image was laid on A and exposed 30 seconds to a "nuArc" xenon arc lamp at a	120
-	methoxyphenyl)-imidazole dimer 2.1 gm tri(4 - diethylamino - 3- methyl)phenyl methane	distance of 40.64 cm. Layer A was then stripped off and the photoresist image developed by spraying for 25 seconds with	
	500 gm methyl alcohol	methyl chloroform followed by 25 seconds	

9	1,385	5,241	9
•	of hot water spray and 15 seconds of cold water spray. The resultant image, with a dyed underlayer replicate, made an excellent photo- mask.	with the developer composition dis- closed in the above reference and a suit- able printing plate was obtained. 2. The following "tacky" photopolymer system was prepared:	65
5	EXAMPLE VI. Solution A, for use as the UV-absorbing layer, was prepared as follows:	40.2% poly(methyl methacrylate), mol. wt. 30,000 50.2% polyoxyethylated trimethylol- propane triacrylate	70
10	2000 gm 15% acrylic hydrosol (described in Example I) 35 gm Dalamar Yellow, Colour Index #11741	5.6% poly(oxyethylene)lauryl ether 0.16% 2-mercaptobenzothiazole 0.16% 7 - diethylamino - 4 - methyl-coumarin	,,
	0.5 gm sodium laurylsulfate 0.05 gm Victoria Pure Blue BO, Colour index #42595	1.6% o - chlorophenyl - 4,5 - bis(m- methoxyphenyl) - imidazole dimer	75
15	1.5 gm 2,2' - dihydroxy - 4 - methoxy- benzophenone 5 gm trimethylolpropane triacrylate	25% solids in trichloroethylene This material was coated to a dry thickness of 0.010 mm on resin subbed polyethylene terephthalate and overcoated by	. 80
20	This solution was stirred for two hours and coated on 0.18 mm polyethylene terephthalate resin-subbed base described in Example III to a dry thickness of 0.05 mm. This material had an optical density of 5—7 between 300 and 500 ma. A photoresist slurry was then prepared which had the following composition:	laminating a 0.019 mm-thick poly- ethylene terephthalate sheet on top. The photomask was imaged on this material by exposure to the xenon arc for 15 seconds at 45.7 cm. The image, which is formed by the hardening of the tacky polymer in the area which was exposed,	8 5
25	5 gm poly(methyl methacrylate) mol. wt. 30,000	was developed after removal of the polyethylene terephthalate cover sheet by dusting with a dry, colored dye which	90
30	1 gm triethyleneglycol diacetate 3 gm trimethylolpropane triacrylate 0.1 gm benzophenone 0.1 gm 4,4' - bis(dimethylamino)benzophenone 1 gm ethyl alcohol	adhered to those tacky portions. This material is described in U.S. Patent 3,307,943. The resultant dyed image was transferred to coated paper stock by lamination at 110°C and an excellent positive copy of the photomask was thus	95
35	methylenechloride to 50 gm. This solution was coated on 0.019 mm-thick polyethylene terephthalate and then laminated to the UV-absorbing layer, as previously described, yielding a composite photopolymerizable film having the structure that is set forth	secured. 3. A moderately slow, ortho-sensitive silver halide film (mainly chlorobromide with small amounts of iodide) was exposed for 10 seconds to the same photomask using a General Electric 100-watt, 20-	100
40	above, where A is polyethylene terephthalate, (a) is the photoresist, (b) is the UV-absorbing layer, and B is resin-subbed polyethylene terephthalate. This sandwich was exposed 5	volt standard incandescent lamp at a distance of 134.6 cm, through a 0.6 neutral density filter and a #47 Wratten filter. The image was de-	105
45	seconds to a SG-60 "Sun Gun" (1000-watt) at a 40.64 cm distance through a photographic, silver halide negative test image laid on top of layer A. Layer A was stripped off and the photoresist image developed by spraying for 10 seconds with chloroform. A 25-	veloped in a standard multiprocess type developer (metol-hydroquinone) fol- lowed by fixing in a conventional photo- graphic fixer, washed and dried as known to those skilled in the art. A very high resolution black and white image	110
50	second spray with 2-ethoxyethanol followed by a 1 minute water wash completed the de- velopment and removed that area of the UV layer under the unexposed region of the photo-	was obtained. EXAMPLE VII. A slurry for use as the UV-absorbing layer was prepared by placing the following com-	115
55	resist that had already been dissolved. After drying, the green colored positive photomask obtained was used to expose the following light-sensitive materials: 1. A photopolymer printing plate described	ponents in a ballmill mixer: 500 gm 15% acrylic hydrosol (same as material described in Example I) 50 gm 10% aqueous saponin solution	120
60	in U.S. Patent 3,458,311 was exposed through this mask for 45 sec. at 91.44	30 gm Latyl Yellow YWL, Colour Index #42 8 gm Latyl Orange NST, Colour Index	

cm under the stand-up carbon arc. The line and halftone pattern was developed

500 gm 15% acrylic hydrosol (same as material described in Example I) 10% aqueous saponin solution Latyl Yellow YWL, Colour Index 50 gm 30 gm #42 8 gm Latyl Orange NST, Colour Index 125

65

85

	25 gm		aldehyde co
		Cyanamid Co.)	by American
5	5 gm	2,2' - dihydroxy - 4 benzophenone	- methoxy-

After mixing for 16 hours, the slurry was filtered through felt and coated to a dried thickness of 0.05 mm on polyethylene terephthalate resin subbed as described in Example 10 IV. The film was then heated to coalesce the polymer upon which a transparent, orange colored film was obtained which exhibited the following optical densities as measured on a Cary Spectrophotometer:

	Wavelength (mu)	Optical Density
	500 .	>4.52
	400	>4.52
20	350 300	>2
20	300	>2

The photoresist element described in Example II was then laminated to this layer in the same manner and exposure-development carried out as described in that Example. This mask material was useful for imaging photoresist clad copper circuit boards.

EXAMPLE VIII.

The following two solutions were prepared:

Solution A (for use in preparing the ultraviolet absorbing layer) The same as described in Example I.

Solution B (for use in preparing the photoresist layer)

Poly(methyl methacrylate/ methacrylic acid) — 90/10 35 mole ratio 53.8 per cent Pentaerythritol triacrylate containing 0.4% of P methoxyphenol as thermal inhibitor 44.1 per cent

Tertiary-butylanthraquinone 2.0 per cent Ethyl Violet (CI Basic Violet 4) Dye 0.1 per cent

The above are represented as percentages of a solution (containing 20% solids) in methyl ethyl ketone/isopropanol 3/1.

Solution A was coated on 0.18 mm-thick polyethylene terephthalate as described in Example I and dried. Solution B was then coated 50 on top of A to a coating weight of approximately 87 mg/dm2 solids and dried. This composition was then overcoated with a 3% aqueous solution of polyvinyl alcohol (medium viscosity, 99% saponified) containing 2% of a polyoxyethylene surfactant as disclosed in U.S. Patent 3,458,311, Example I. The resulting, dried polyvinyl alcohol coating weight

was 12 mg/dm. The composite coating was then given a 30-second exposure to a "nuArc" "Flip-Top" Plate Maker, Model FT 26M-2 stand-up carbon arc through a test image simulating an integrated electrical circuit at e distance of 43.18 cm and the resulting photoresist image developed using a developer of the following composition:

Isopropyl alcohol (99%) 10% by volume 0.1% by weight 89.5% by volume Sodium hydrozide

The plate was covered by the developer and allowed to soak for 30 seconds. The entire protective layer, along with the unexposed areas of the photopolymerizable layer and the dyed polymer layer underneath the corresponding areas was removed by sponging. The developed plate was rinsed in water and dried and a yellow colored copy of the original was produced which was suitable for use as a mask.

It is not essential to provide the element layers interposed between a support and cover sheet. Other modifications can be made, for example, by providing the UV-absorbing layer (b) with sufficient thickness so that a portion of that layer can be thermally hardened to provide support for the element. Moreover, removal of the cover sheet can provide a practical system. The modifications described and shown are preferred.

EXAMPLE IX.

CQ Solution A (the UV absorber layer) was prepared and coated on 0.18 mm-thick polyethylene terephthalate film as described in Enample I. A cross-linkable isoprene resist which has been identified by W. L. Hunter and P. F. Crabtree and reported in Photographic Science and Engineering, Vol. 13, No. 5, p.271 (1969) (sold by Eastman Kodait Company as "Kodait Thin Film Resist") was coared on top of the dried UV absorber layer using a 0.05 mm 100 doctor knife. After drying the resist layer at 38°C for 2 minutes, it was emposed to a test image as described in Example I and the resulting product developed in a zylene based developer furnished by the manufacturer of 103 the resist formulation (Eastman Kodal: Co. "Metal Etch Resist Developer") by sozking for 10 minutes at room temperature. The plate was then rinsed in a 59/50 mixture of emyl alcohol and water. The resulting mask which 110 was produced was suitable for preparing other copies.

EXAMPLE X.

Solution A of Example I (for the UV absorber layer) was prepared and coated as in 115 Example IX and dried. The following mixture was then coated on top using a 0.05 mm doctor knife:

11	1,385	5,241	11
	10 g. photographic grade gelatin 90 g. distilled water 5 g. potassium dichromate 5 g. 10% aqueous saponin solution	adding 4,4'-bis(dimethylamine)benzophenone (0.01 g. of the sensitizer per 6.5 g. solution). The resulting solution was spray coated on top of the above UV absorber layer and dried. The dried layer was about 0.003 mm thick. The	60
5	The gelatin was dissolved in the water by soaking at 38°C. and the potassium dichromate and sponin then added slowly with stirring. After coating this mixture on the UV absorber	test image was then laid on top of this element and exposed as in Example I and the resulting product developed by soaking for 30 seconds in 1,1,1-trichloroethane. A colored	65
10	layer above, the coating was dried with warm air and the resulting plate given a 5 minute exposure through the test image using the same exposure conditions and light source as	copy of the original was obtained which was suitable for preparing further copies. EXAMPLE XIII.	70
15	in Example I. The exposed film was then developed by soaking 30 seconds in the following solution: 9.6 g. sodium borate decahydrate	The following solution was prepared: Copolymer of ethyl acrylate (ca. 88%) and acrylic acid (ca. 12%)* 100 g.	7 5
20	2.0 g. 10% octylphenoxy ethanol in water 180.0 g. 2-(2-butoxy ethanol) Water to 1 liter	NH ₁ OH solution (Saturated, approx. 58% NH ₂) 12 g. Distilled water 838 g.	
	The developed image was then rinsed in cold water and dried. A yellow copy of the original, opaque to radiation between 200—500 mu, and suitable for use as a mask of the original	50 g. of this solution was mixed with 50 g. of the acrylic hydrosol described in Example I plus 5 g. of 25% water solution of a fluorinated hydrocarbon of the structure described in Example I. Then, 10 g. of solid potassium	
25	remained. EXAMPLE XI.	permanganate were added and the mixture stirred for 2 hours until all gas evolution ceased. 10 ml of 2-(2-ethoxy ethanol) was	85
30	Solution A (the UV absorber layer) was prepared and coated as described in Example IX. A crosslinkable, photosensitive composition was prepared as described in Example I of Specification No. 1,324,548 by dissolving 0.5 g of (1,4 - butanediol)dibenzoate 4,4'-bis(diazonium zinc chloride) in 25 ml of	added and the solution coated on 0.12 mm thick polyethylene terephthalate film as in Example I using a 0.05 mm doctor knife to yield a dry coating weight of 50 mg/dm². This structure was then overcoated with the photosensitive resist formulation of Example I (Solution B) and laminated, exposed to a test	90
25	acetone containing 2.5 g. of poly(methylmeth- acrylate/hydroxyethyl methacrylate) (MW= 30,000; 90 mole percent methylmethacrylate), 0.5 g p-toluenesulfonic acid, 1.0 g triethylene glycol diacetate, 2 cc of ethanol and 1 mi of	image and developed in the same manner as described in Example I. The brown, MnO: copy of the original image absorbed strongly between 200—500 mµ and was a useful mask-copy of the original.	95
40	water; the composition was coated on top of the dried UV absorber layer. A test image was then placed on the dried, photosensitive layer and exposed for 2 minutes at a distance of 61 cm to a 2,500-watt, 14 ampere carbon arc.	[The terms "LUXOL", "PARLOR!" "PLASTO", "nuArc", "Flip-Top", "Sun- Gun" and "Cymel" are Registered Trace Marks.] in the above solution has a tensile strength of	100
! 5	treated with ammonia fumes and then developed by washing out the exposed areas with 1,1,1-trichloroethane. The solvent used to develop the element by washing out the exposed areas with the trichloroethane.	4100 PST. WHAT WE CLAIM IS:—	105
50	posed areas of the photosensitive composition also removed the same areas of the UV absorber layer leaving a positive image of the original which was rutable for use as a photomask for imaging subsequent copies.	A composite, photosensitive element which comprises: (a) a photosensitive layer comprising either (i) a photohardenable material which harden upon exposure to actinic radiation or (ii) a positive block to executive actinic radiation or (ii) and the compositive block to the compositive description.	: : : 110
	EXAMPLE XII.	crosslinkable photosensitive composition which undergoes decomposition upon exposure to actinic radiation to leave material in the unactinic radiation and the unac	•

Solution A (the UV absorber layer) was prepared, coated and dried as in Example IX.

55 A diallyl isophthalate prepolymer was then made according to the method of U.S. Patent 3,376,139. This photosensitive prepolymer was then dissolved in methyl isobutyl ketone (about 5:1 solvent:prepolymer) and sensitized by

*This copolymer is a thermoplastic acrylic polymer molecular weight approximately 260,000 and containing a number of carboxylic acid groups. The NH \$\Phi\$ salt formed

exposed areas which crosslinks and hardens upon treatment with a basic crosslinking agent; 115

70

and, in intimate surface contact therewith,

(b) a layer of a solvent-soluble (as hereinbefore defined), macromolecular organic polymer which layer (b) contains at least one dye or pigment and is essentially opaque to ultra-violet radiation and essentially transparent to visible actinic radiation.

2. An element according to claim 1, wherein the layer (a) is adherent to a cover sheet and the layer (b) is adherent to a support

film.

3. An element according to claim 1 or 2, wherein layer (b) has an optical density of 1.5 to 5.0 in the region of the actinic spectrum responsible for initiation of the photosensitising reaction.

4. An element according to any one of the preceding claims, wherein the layer (a) comprises, as photohardenable material, an addition polymerisable monomer and a polymeric binder.

5. An element according to claim 4, wherein the addition polymerisable monomer contains at least one methacrylate group.

6. An element according to any one of claims 1 to 3, wherein the layer (a) comprises a photohardenable material which is uniformly crosslinkable.

7. An element according to claim 2, wherein the support film has greater adherence to layer (b) than the cover sheet has to layer (a).

8. An element according to claim 2, wherein the support film has lesser adherence to layer (b) than the cover sheet has to layer (a).

 A composite photohardenable element according to Claim 1 substantially as hereinbefore described.

10. A process for the preparation of a coloured mask which comprises imagewise exposing to actinic radiation a composite element as claimed in any one of claims 2 to 8,

the element being exposed through the cover sheet adherent to layer (a), removing the cover sheet, removing the unhardened areas of layer (a) and removing the portion of layer (b) underlying the unhardened areas of layer (a).

11. A process according to claim 10 wherein the portion of layer (b) underlying the unhardened areas of layer (a) is removed by washing those portions with a solvent for the material of layer (b).

12. A process according to claim 10 wherein the unhardened areas of layer (a) are removed by moshing the plant of layer (b) are removed

by washing the element in a liquid which is a solvent for both the material in the unhardened areas or layer (a) and for the

material of layer (b).

13. A process for the preparation of a coloured mask which comprises removing the support film from an element as claimed in any one of claims 2 to 8, laminating the element to a rigid support, with the layer (b) mearest the rigid support, exposing the layer (a) imagewise to actinic radiation, removing the cover sheet on the layer (a) and removing the unhardened areas of the layer (a) and the portion of the layer (b) underlying the unhardened areas of layer (a) leaving a photomask on the rigid support.

14. A process for the preparation of a coloured mask from an element as claimed in any one of claims 1 to 9 substantially as

hereinbefore described.

15. Coloured masks whenever prepared by a process as claimed in any one of claims 10 to 14.

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